

FORM PTO-1449

Department of Commerce  
Patent and Trademark OfficeAtty. Docket No.  
P29987Application No.  
10/595,914INFORMATION DISCLOSURE STATEMENT  
BY APPLICANT  
(Use several sheets if necessary)Applicant  
Akira OTANI et al.Filing Date  
I.A. Filed December 2, 2004Group  
1773

## U.S. PATENT DOCUMENTS

EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
/A.K./	2001 /	0 0 0 8 1 6 9	07/19/01	CONNELL et al.			
/A.K./		5 2 4 0 7 6 1	08/31/93	CALHOUN et al.			

## FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION YES	NO
/A.K./	11	- 1 2 1 0 7 2	04/30/99	JAPAN				
	<del>2002</del>	<del>5 1 9 4 7 3</del>	<del>07/02/02</del>	<del>JAPAN</del>				
/A.K./	2000	- 1 4 9 6 7 7	05/30/00	JAPAN				
/A.K./	2002	- 3 5 8 8 2 5	12/13/02	JAPAN				
/A.K./	2003	- 0 6 4 3 2 4	03/05/03	JAPAN				
	<del>2</del>	<del>1 1 7 0 8 0</del>	<del>06/03/00</del>	<del>JAPAN</del>				
/A.K./	6	- 3 4 9 3 3 9	12/22/94	JAPAN				
	<del>2</del>	<del>8 0 5 8 7 2</del>	<del>03/05/00</del>	<del>JAPAN</del>				
	<del>2</del>	<del>1 6 5 4 7 7</del>	<del>03/03/01</del>	<del>JAPAN</del>				
/A.K./	6	- 0 6 0 7 1 2	03/04/94	JAPAN				
/A.K./	6	- 0 4 5 0 2 4	02/18/94	JAPAN				

## OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

/A.K./	1	English Language Abstract of JP 11-121072.
/A.K./	2	English Language Abstract of JP 2000-149677.
/A.K./	3	English Language Abstract of JP 2002-358825.
/A.K./	4	English Language Abstract of JP 2003-064324.
/A.K./	5	English Language Abstract of JP 6-349339.
	<del>6</del>	<del>English Language Abstract of JP 2895872</del>
	<del>7</del>	<del>English Language Abstract of JP 3165477</del>
/A.K./	8	English Language Abstract of JP 6-060712.
/A.K./	9	English Language Abstract of JP 6-045024.
/A.K./	10	U.S. Application Serial No. 10/567,022 filed February 3, 2006 and entitled "COMPOSITE POROUS MEMBRANE AND PROCESS FOR PRODUCING THE SAME".
/A.K./	11	U.S. Application Serial No. 10/574,837 filed April 6, 2006 and entitled "POLYOXYMETHYLENE RESIN COMPOSITION AND MOLDINGS THEREOF".
/A.K./	12	U.S. Application Serial No. 10/576,259 filed April 18, 2006 and entitled "POLYTRIMETHYLENE TEREPHTHALATE REINFORCED RESIN COMPOSITION".
/A.K./	13	U.S. Application Serial No. 10/582,556 filed June 9, 2006 and entitled "THERMOPLASTIC RESIN COMPOSITION".
/A.K./	14	U.S. Application Serial No. 10/597,091 filed July 11, 2006 and entitled "RESIN AND RESIN COMPOSITION".
/A.K./	15	U.S. Application Serial No. 10/597,336 filed July 20, 2006 and entitled "POLYACETAL RESIN COMPOSITION".

EXAMINER /Adam Krupicka/

DATE CONSIDERED 04/06/2009

\*EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.